SURFACE MOUNT LED LAMPS **SMD Chip LED Lamps** Part NO.: Code NO.: N0D38S93 Package outlines 1.60 [0.06"] Polarity Mark **RECOMMEND PAD LAYOUT** 2 [80'0] 4 0.80 [0.03"] [0.01"] 108.0 0.30 3 1.20 [0.05"] 2.60 [0.10"] [0.01"] 1.10 [0.04"] [0.02"] 0.18 **ATTENTION OBSERVE PRECAUTIONS** 0.55 FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES 0.40 [0.02"] [0.01"] 3 0.25 0 ITEM MATERIALS Resin (mold) Epoxy 2 4 Lens color Water transparent 4 0-IR AlGaAs/AlGaAs Dice AlGaInP 3 0-Orange

NOTES:

- 1. All dimensions are in millimeters (inches); 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

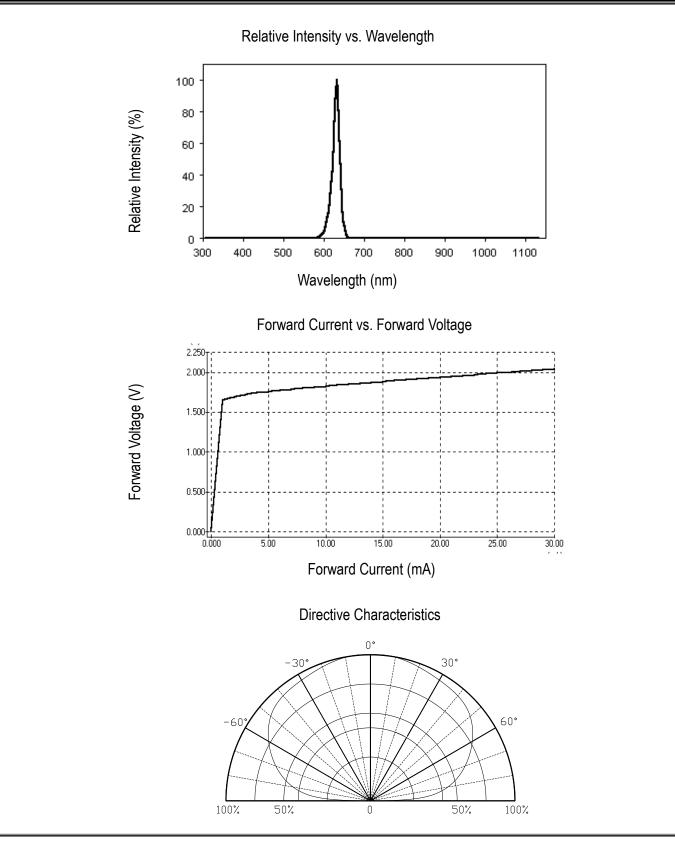
Rev :	Date	Drawn by :	Checked by :	Approved by :	
A	2016/12/12	唐云	李用基	黄靜文	

SURFACE MOUNT	LED LAMP	PS					
Part NO.:	C	ode NC).: N	10D38	S93		
Absolute maximum rating	S					(T _A =	25°C)
Parameter		Symbol		IR	Value	0	Unit
Power dissipation		Pd		90		75	mW
Forward current		lf		50		30	
Reverse voltage			Vr		5		
Operating temperature range			Тор		-40 ~+80		
Storage temperature range			Tstg		-40 ~+85		
Peak pulsing current (1/8 duty f=1kH	z)	lfp			125		mA
Electro-optical characteris	stics					(T _A =2	25℃)
Parameter	Test	Symbol		Value			Unit
Falameter	Condition	Cynns		Min	Тур	Max	Unit
Wavelength at peak emission	lf=20mA	λ peak	0 IR	 870	635 880	 890	nm
Spectral half bandwidth	lf=20mA	$ riangle \lambda$	0 IR		18 70		nm
Dominant wavelength	lf=20mA	λ dom	0 IR	615 	622 	630 	nm
Forward voltage	lf=20mA	Vf	0 IR	1.7 1.0	2.0 1.4	2.5 1.8	V
	lf=20mA	lv	0	50	90	160	mcd
Luminous intensity				0.1	1 0 0 5	1 91	mW/sr
Luminous intensity Viewing angle at 50% Iv	lf=10mA	Ρο 2 <i>θ</i> 1/	IR 2		0.95 140	2.1 	Deg

Part NO.:

Code NO.: N0D38S93

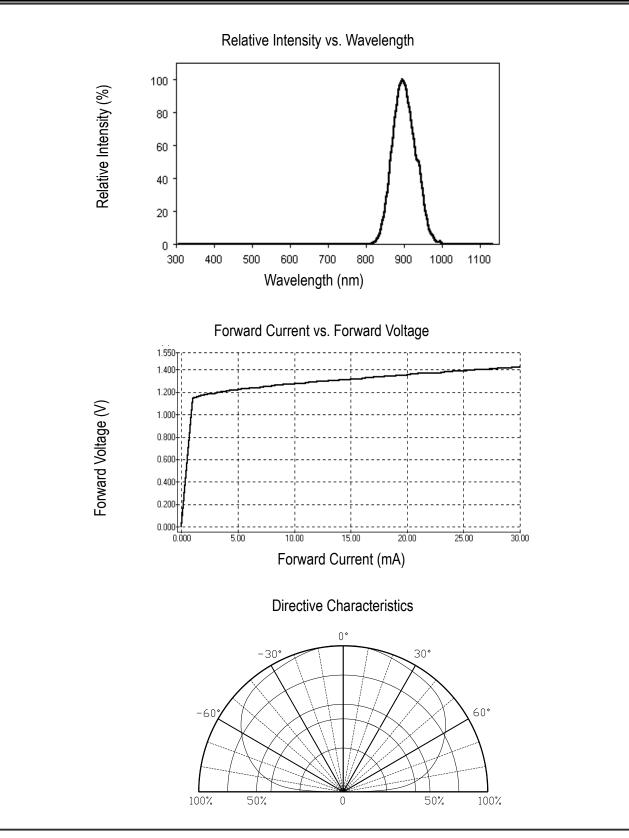
OPTICAL CHARACTERISTIC CURVES (Orange)



Part NO.:

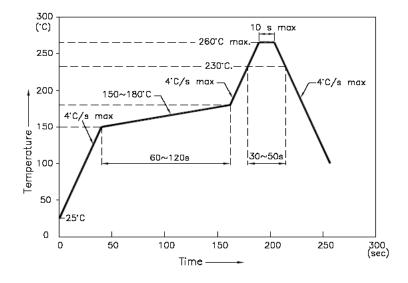
Code NO.: N0D38S93

OPTICAL CHARACTERISTIC CURVES (IR)



Reflow Profile

Reflow Temp/Time



NOTES:

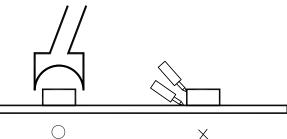
- 1. We recommend the reflow temperature 245 °C (±5 °C).the maximum soldering temperature should be limited to 260 °C.
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

Rework

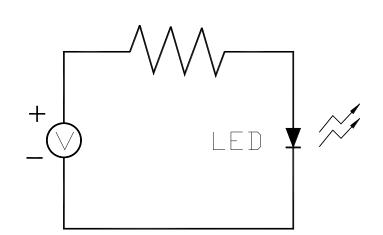
- 1. Customer must finish rework within 5 sec under 260 $^\circ\mathrm{C}$.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

Test circuit



- Handling precautions
 - 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Shelf life in sealed bag: 12 month at 5° C ~30 $^{\circ}$ C and <60% R.H;
- 3. After the package is Opened:
- 3.1. It is recommended to baking before the first use:

Baking condition:

- a. 60 \pm 5°C x (24~48hrs) and <5%RH, taped reel type ;
- b. 110 \pm 5°C x (8~16hr), bulk type ;
- 3.2. The products should be used within a week and to be stored at \leq 20% R.H. with zip-lock sealed:
 - a. Baking is required before soldering when the pack is unsealed after 24hrs ;
 - b. Baking condition as 3.1 baking condition.

Test items and results of reliability

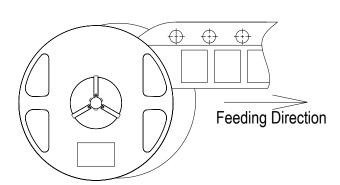
Туре	Test Item	Test Conditions	Note	Number of Damaged	
	Temperature Cycle	-20℃ 30min ↑↓ 80℃ 30min	100 cycle	0/22	
	Thermal Shock	-20℃ 15min ↑↓ 80℃ 15min	100 cycle	0/22	
Environmental Sequence	High Humidity Heat Cycle	30° C ⇔ 65° C 90%RH 24hrs/1cycle	10 cycle	0/22	
	High Temperature Storage	Ta =80 ℃	1000 hrs	0/22	
	Humidity Heat Storage	Ta=60°C RH=90%	1000 hrs	0/22	
	Low Temperature Storage	Ta=-30℃	1000 hrs	0/22	
Operation Sequence	Life Test	T _a =25°C I _F =20mA	1000 hrs	0/22	
	High Humidity Heat Life Test 60° C RH=90% I _F =10mA		500 hrs	0/22	
	Low Temperature Life Test	T _a =-20°C I _F =20mA	1000 hrs	0/22	

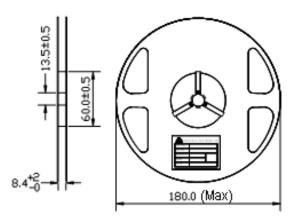
PACKAGING SPECIFICATIONS

SMD Chip LED Lamps Packaging Specifications

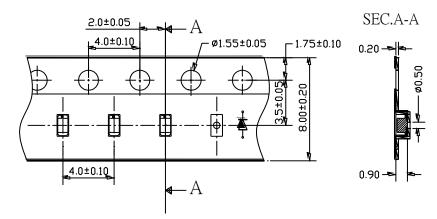
• Feeding Direction

• Dimensions of Reel (Unit: mm)

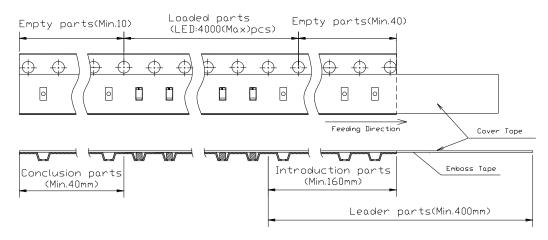




• Dimensions of Tape (Unit: mm)



• Arrangement of Tape



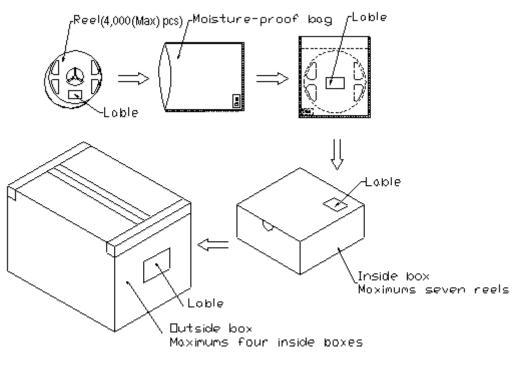
NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 4,000(Max)pcs/Reel

PACKAGING SPECIFICATIONS

SMD Chip LED Lamps Packaging Specifications

• Packaging specifications



NOTES:

Reeled products [numbers of products are 4,000(Max)pcs] packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums [total maximum number of products are 28,000(Max)pcs] packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.

SURF	ACE]	MOUNT	Г LED L	AM	PS				
Part NC).:				Code N	O.: N0D38S93	3		
Forward	Voltage	Rank Com	bination (II	F=20m	A)				
Rank C	Code		Min. N		Max.	Max.			
Orange 🗌		1.7	1.7 2.5			- V			
IR	IR 🗌			1.0			1.8		
Luminou	us Intens	sity Rank C	ombination	า (IF=2	0mA)			I	
Rank C	Code		Min.			Max.		Unit	
	G		50			63			
	Н		63			80		1	
Orange	I		80			100			
5	J		100			125			
	K		125			160		mcd	
	Α		0.10			0.60			
IR	В		0.60			1.10	1.10		
IR	С		1.10			1.60			
	D		1.60		2.10				
Dominar	nt/Peak	wavelength	Rank Com	nbinati	on (IF=2	20mA)			
Rank Code			Min.		Max.		Unit		
	S		615			620			
Orange	t		620		625				
	u	625			630			nm	
IR			870			890			
Group N	ame on	Label (Example D	ATA: [B □ 20)			
DATA: C	□lt [Drange	□B□ 20 IR	Vf(V)	•	mcd)/ nW/sr)	λ d/ λ p (nm)	Те	st Condition	
Orange)→t→20	1.7~2.5	80~100		620~625			
		$3 \rightarrow \Box \rightarrow 20$	0.8~1.6	1.6 0.6~1.7		6~1.1 870~890		IF=20mA	

* NOTE:

1. The tolerance of luminous intensity (Iv)is $~\pm 15\%$.

2. The tolerance of dominant wavelength/Peak wavelength is ± 1.5 nm.

3. This specification is preliminary.